National Semiconductor

August 1996

NM93CS06L/CS46L/CS56L/CS66L 256-/1024-/2048-/4096-Bit Serial EEPROM with Extended Voltage (2.7V to 5.5V) and Data Protect (MICROWIRE™ Bus Interface)

General Description

The NM93CS06L/CS46L/CS56L/CS66L devices are 256/1024/2048/4096 bits, respectively, of non-volatile electrically erasable memory divided into 16/64/128/256 x 16-bit registers (addresses). The NM93CSxxL Family functions in an extended voltage operating range, and is fabricated using National Semiconductor's floating gate CMOS technology for high reliability, high endurance and low power consumption. N registers ($N \leq 16$, $N \leq 64$, $N \leq 128$, $N \leq 256$) can be protected against data modification by programming the Protect Register with the address of the first register to be protected against data modification. (All registers greater than, or equal to, the selected address are then protected from further change.) Additionally, this address can be ''locked'' into the device, making all future attempts to change data impossible.

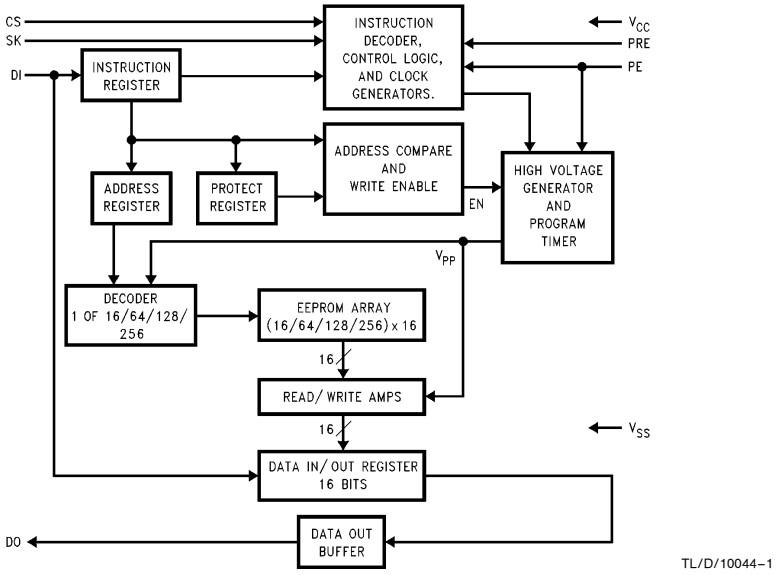
These devices are available in both SO and TSSOP packages for small space considerations.

The serial interface that controls these EEPROMs is MICROWIRE compatible, providing simple interfacing to standard microcontrollers and microprocessors. There are a total of 10 instructions, 5 which operate on the EEPROM memory and 5 which operate on the Protect Register. The memory instructions are READ, WRITE, WRITE ALL, WRITE ENABLE, and WRITE DISABLE. The Protect register instructions are PRREAD, PRWRITE, PRCLEAR, PRDISABLE and PRENABLE.

Features

- Sequential register read
- Write protection in a user defined section of memory
- 2.7V to 5.5V operating range in all modes
- Typical active current of 200 μA; typical standby current of 1 μA
- No erase required before write
- Reliable CMOS floating gate technology
- MICROWIRE compatible serial I/O
- Self timed write cycle
- Device status during programming mode
- 40 year data retention
- Endurance: 10^6 data changes
- Packages Available: 8-pin SO, 8-pin DIP, and 8-pin TSSOP

Block Diagram



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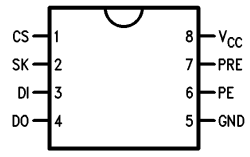
MICROWIRE™ is a trademark of National Semiconductor Corporation.

NM93CS06L/CS46L/CS56L/CS66L 256-/1024-/2048-/4096-Bit Serial EEPROM with Extended Voltage (2.7V to 5.5V) and Data Protect (MICROWIRE Bus Interface)

Connection Diagrams

Dual-In-Line Package (N)
8-Pin SO Package (M8) and 8-Pin TSSOP Package (MT8)



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Top View

See NS Package Number N08E (N)
See NS Package Number M08A (M8)
See NS Package Number MTC08 (MT8)

Pin Names

CS	Chip Select
SK	Serial Data Clock
DI	Serial Data Input
DO	Serial Data Output
GND	Ground
PE	Program Enable
PRE	Protect Register Enable
V_{CC}	Power Supply

Ordering Information

Commercial Temp. Range (0°C to +70°C)

Order Number
NM93CS06LN/NM93CS46LN/NM93CS56LN/NM93CS66LN NM93CS06LM8/NM93CS46LM8/NM93CS56LM8/NM93CS66LM8 NM93CS46LMT8/NM93CS56LMT8/NM93CS66LMT8

Extended Temp. Range (−40°C to +85°C)

Order Number
NM93CS06LEN/NM93CS46LEN/NM93CS56LEN/NM93CS66LEN NM93CS06LEM8/NM93CS46LEM8/NM93CS56LEM8/NM93CS66LEM8 NM93CS46LEMT8/NM93CS56LEMT8/NM93CS66LEMT8

Automotive Temp. Range (−40°C to +125°C)

Order Number
NM93CS06LVN/NM93CS46LVN/NM93CS56LVN/NM93CS66LVN NM93CS06LVM8/NM93CS46LVM8/NM93CS56LVM8/NM93CS66LVM8 NM93CS46LVMT8/NM93CS56LVMT8/NM93CS66LVMT8

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Ambient Storage Temperature	−65°C to +150°C
All Input or Output Voltages with Respect to Ground	+6.5V to −0.3V
Lead Temperature (Soldering, 10 sec.)	+300°C
ESD rating	2000V

Operating Conditions

Ambient Operating Temperature	
NM93CSxxL	0°C to +70°C
NM93CSxxLE	−40°C to +85°C
Power Supply (V_{CC}) Range	
Read Mode	2.0V to 5.5V
WRALL Bulk Programming	3.0V to 5.5V
All Other Modes	2.5V to 5.5V

DC and AC Electrical Characteristics: 2V < V_{CC} < 4.5V

Symbol	Parameter	Conditions	Min	Max	Units
I_{CCA}	Operating Current	CS = V_{IH}, SK = 250 kHz		1	mA
I_{CCS}	Standby Current	CS = V_{IL}		50	μA
I_{IL} I_{OL}	Input Leakage Output Leakage	V_{IN} = 0V to V_{CC} (Note 4)		±1	μA
V_{IL} V_{IH}	Input Low Voltage Input High Voltage		−0.1 0.8 V_{CC}	0.15 V_{CC} V_{CC} + 1	V
V_{OL} V_{OH}	Output Low Voltage Output High Voltage	I_{OL} = 10 μA I_{OH} = −10 μA	 0.9 V_{CC}	0.1 V_{CC}	V
f_{SK}	SK Clock Frequency	(Note 5)	0	250	kHz
t_{SKH}	SK High Time		1		μs
t_{SKL}	SK Low Time		1		μs
t_{SKS}	SK Setup Time	SK must be at V_{IL} for t_{SKS} before CS goes high	0.2		μs
t_{CS}	Minimum CS Low Time	(Note 2)	1		μs
t_{CSS}	CS Setup Time		0.2		μs
t_{PRES}	PRE Setup Time		0.2		μs
t_{PES}	PE Setup Time		0.2		μs
t_{DIS}	DI Setup Time		0.4		μs
t_{DH}	DO Hold Time		70		ns
t_{CSH}	CS Hold Time		0		μs
t_{PEH}	PE Hold Time		0.4		μs
t_{PREH}	PRE Hold Time		0.4		μs
t_{DIH}	DI Hold Time		0.4		μs
t_{PD1}	Output Delay to "1"			2	μs
t_{PD0}	Output Delay to "0"			2	μs
t_{SV}	CS to Status Valid			1	μs
t_{DF}	CS to DO in TRI-STATE®	CS = V_{IL}		0.4	μs
t_{WP}	Write Cycle Time			15	ms

DC and AC Electrical Characteristics: 4.5V $< V_{CC} <$ 5.5V

Symbol	Parameter	Part Number	Conditions	Min	Max	Units
I_{CCA}	Operating Current CMOS Input Levels		CS = V_{IH}, SK = 1.0 MHz		1	mA
I_{CCS}	Standby Current		CS = V_{IL}		50	μA
I_{IL} I_{OL}	Input Leakage Output Leakage		V_{IN} = 0V to V_{CC} (Note 4)		$\pm$1	μA
V_{IL} V_{IH}	Input Low Voltage Input High Voltage			$-$0.1 2	0.8 $V_{CC}+1$	V
V_{OL1} V_{OH1}	Output Low Voltage Output High Voltage		I_{OL} = 2.1 mA I_{OL} = 400 μA	2.4V	0.4	V
V_{OL2} V_{OH2}	Output Low Voltage Output High Voltage		I_{OL} = 10 μA I_{OL} = $-$10 μA	$V_{CC}-0.2$	0.2	V
f_{SK}	SK Clock Frequency		(Note 5)	0	1	MHz
t_{SKH}	SK High Time	NM93CS06L-NM93CS66L NM93CS06LE-NM93CS66LE		250 300		ns
t_{SKL}	SK Low Time			250		ns
t_{SKS}	SK Setup Time		SK must be at V_{IL} for t_{SKS} before CS goes High	50		ns
t_{CS}	Minimum CS Low Time		(Note 2)	250		ns
t_{CSS}	CS Setup Time			50		ns
t_{PRES}	PRE Setup Time			50		ns
t_{DH}	DO Hold Time			70		ns
t_{PES}	PE Setup Time			50		ns
t_{DIS}	DI Setup Time			100		ns
t_{CSH}	CS Hold Time			0		ns
t_{PEH}	PE Hold Time			250		ns
t_{PREH}	PRE Hold Time			50		ns
t_{DIH}	DI Hold Time			20		ns
t_{PD1}	Output Delay to ''1''				500	ns
t_{PD0}	Output Delay to ''0''				500	ns
t_{SV}	CS to Status Valid				500	ns
t_{DF}	CS to DO in TRI-STATE		CS = V_{IL}		100	ns
t_{WP}	Write Cycle Time				10	ms

Capacitance (Note 3)

$T_A = 25°C$ f = 1 MHz

Symbol	Test	Max	Units
C_{OUT}	Output Capacitance	5	pF
C_{IN}	Input Capacitance	5	pF

Note 1: Stress ratings above those listed under ''Absolute Maximum Ratings'' may cause permanent damage to the device. This is a stress rating only and operation of the device at these or any other conditions above those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: CS (Chip Select) must be brought low (to V_{IL}) for an interval of t_{CS} in order to reset all internal device registers (device reset) prior to beginning another opcode cycle (This is shown in the opcode diagrams in the following pages).

Note 3: This parameter is periodically sampled and not 100% tested.

Note 4: Typical leakage values are in the 20 nA range.

Note 5: The shortest allowable SK clock period $= 1/f_{SK}$ (as shown under the f_{SK} parameter). Maximum SK clock speed (minimum SK period) is determined by the interaction of several AC parameters stated in the datasheet. Within this SK period, both t_{SKH} and t_{SKL} limits must be observed. Therefore, it is not allowable to set $1/f_{SK} = t_{SKH\ (minimum)} + t_{SKL\ (minimum)}$ for shorter SK cycle time operation,

AC Test Conditions

V_{CC} Range	V_{IL}/V_{IH} Input Levels	V_{IL}/V_{IH} Timing Level	V_{OL}/V_{OH} Timing Level	I_{OL}/I_{OH}
$2.0V \leq V_{CC} < 4.5V$ (Extended Voltage Levels)	0.3V/1.8V	1.0V	0.8V/1.5V	$\pm 10\ \mu A$
$4.5V \leq V_{CC} \leq 5.5V$ (TTL Levels)	0.4V/2.4V	1.0V/2.0V	0.4V/2.4V	−2.1 mA/0.4 mA
Output Load: 1 TTL Gate ($C_L = 100$ pF)				

Functional Description

The extended voltage EEPROMs of the NM93CSxxL Family have 10 instructions as described below. Note that MSB of any instruction is a ''1'' and is viewed as a start bit in the interface sequence. For the CS06 and CS46 the next 8 bits carry the opcode and the 6-bit address for register selection. For the CS56 and CS66, the next 10 bits carry the opcode and the 8-bit address for register selection. All Data In signals are clocked into the device on the low-to-high SK transition.

Read and Sequential Register Read (READ):

The READ instruction outputs serial data on the D0 pin. After a READ instruction is received, the instruction and address are decoded, followed by data transfer from the selected memory register into a 16-bit serial-out shift register. A dummy bit (logical 0) precedes the 16-bit data output string. Output data changes are initiated by a low to high transition of the SK clock. In the **Sequential Read** mode of operation, the memory automatically cycles to the next register after each 16 data bits are clocked out. The dummy-bit is suppressed in this mode and a continuous string of data is obtained.

Write Enable (WEN):

When V_{CC} is applied to the part, it ''powers up'' in the Write Disable (WDS) state. Therefore, all programming modes must be preceded by a Write Enable (WEN) instruction. Once a Write Enable instruction is executed, programming remains enabled until a Write Disable (WDS) instruction is executed or V_{CC} is removed from the part.

Write (WRITE):

The WRITE instruction is followed by 16 bits of data to be written into the specified address. After the last bit of data is allocated to the data-in (DI) pin, CS must be brought low before the next rising edge of the SK clock. This falling edge of the CS initiates the self-timed programming cycle. The PE pin **MUST** be held high while loading the WRITE instruction; however, after loading the WRITE instruction, the PE pin becomes a ''don't care''. The D0 pin indicates the READY/BUSY status of the chip if CS is brought high after the t_{CS} internal. D0 = logical 0 indicates that programming is still in progress. D0 = logical 1 indicates that the register at the address specified in the instruction has been written with the data pattern specified in the instruction and that the part is ready for another instruction.

Write All (WRALL):

The WRALL instruction is valid only when the Protect Register has been cleared by executing a PRCLEAR instruction. The WRALL instruction will simultaneously program all registers with the data pattern specified in the instruction. Like the WRITE instruction, the PE pin **MUST** be held high while loading the WRALL instruction; however, after loading the WRITE instruction, the PE pin becomes a ''don't care''. As in the WRITE mode, the DO pin indicates the READY/BUSY status of the chip if CS is brought high after the t_{CS} interval. This function is DISABLED if the protect register is in use to lock out a section memory.

Write Disable (WDS):

To protect against accidental data disturb, the WDS instruction disables all programming modes and should follow all programming operations. Execution of a READ instruction is independent of both the WEN and WDS instructions.

Note: For all protect register operations: If the PRE pin is not held at V_{IH}, all instructions will be applied to the EEPROM array, rather than the Protect Register.

Protect Register Read (PRREAD):

The PRREAD instruction outputs the address stored in the Protect Register on the DO pin. The PRE pin **MUST** be held high while loading the instruction sequence. Following the PRREAD instruction the 6- or 8-bit address stored in the memory protect register is transferred to the serial out shift register. As in the READ mode, a dummy bit (logical 0) precedes the 6- or 8-bit address string.

Protect Register Enable (PREN):

The PREN instruction is used to enable the PRCLEAR, PRWRITE, and PRDS modes. Before the PREN mode can be entered, the part must be in the Write Enable (WEN) mode. Both the PRE and PE pins **MUST** be held high while loading the instruction sequence.

Note that a PREN instruction must **immediately** precede a PRCLEAR, PRWRITE, or PRDS instruction.

Protect Register Clear (PRCLEAR):

The PRCLEAR instruction clears the address stored in the Protect Register and therefore enables **all** registers for the WRITE and WRALL instruction. The PRE and PE pins **must** be held high while loading the instruction sequence; however, after loading the PRCLEAR instruction, the PRE and PE pins become ''don't care''. Note that a PREN instruction must **immediately** precede a PRCLEAR instruction.

Please note that the PRCLEAR instruction and the PRWRITE instruction will both program the Protect Register with all 1s. However, the PRCLEAR instruction will allow the LAST register to be programmed, whereas the PRWRITE instruction = all 1s will PREVENT the last register from being programmed. In addition, the PRCLEAR instruction will allow the use of the WRALL command, where the PRWRITE = all 1s will lock out the Bulk programming opcode.

Protect Register Write (PRWRITE):

The PRWRITE instruction is used to write into the Protect Register the address of the first register to be protected. After the PRWRITE instruction is executed, all memory registers whose addresses are greater than or equal to the address specified in the Protect Register are protected from the WRITE operation. Note that before executing a PRWRITE instruction, the Protect Register must first be cleared by executing a PRCLEAR operation and the PRE and PE pins **must** be held high while loading the instruction; however, after loading the PRWRITE instruction, the PRE and PE pins become ''don't care''. Note that a PREN instruction must **immediately** precede a PRWRITE instruction.

Protect Register Disable (PRDS):

The PRDS instruction is a **ONE** TIME ONLY instruction which renders the Protect Register unalterable in the future. Therefore, the specified registers become **PERMANENTLY** protected against data changes. As in the PRWRITE instruction the PRE and PE pins **must** be held high while loading the instruction, and after loading the PRDS instruction the PRE and PE pins become ''don't care''.

Note that a PREN instruction must **immediately** precede a PRDS instruction.

Instruction Set for the NM93CS06L and NM93CS46L

Instruction	SB	Op Code	Address	Data	PRE	PE	Comments
READ	1	10	A5–A0		0	X	Reads data stored in memory, starting at specified address.
WEN	1	00	11XXXX		0	1	Enable all programming modes.
WRITE	1	01	A5–A0	D15–D0	0	1	Writes address if unprotected.
WRALL	1	00	01XXXX	D15–D0	0	1	Writes all registers. Valid only when Protect Register is cleared.
WDS	1	00	00XXXX		0	X	Disables all programming modes.
PRREAD	1	10	XXXXXX		1	X	Reads address stored in Protect Register.
PREN	1	00	11XXXX		1	1	Must immediately precede PRCLEAR, PRWRITE, and PRDS instructions.
PRCLEAR	1	11	111111		1	1	Clears the Protect Register so that no registers are protected from WRITE.
PRWRITE	1	01	A5–A0		1	1	Programs address into Protect Register. Thereafter, memory addresses ≥ the address in Protect Register are protected from WRITE.
PRDS	1	00	000000		1	1	**ONE TIME ONLY** instruction after which the address in the Protect Register cannot be altered.

Note: Address bits A5 and A4 become ''Don't Care'' for the NM93CS06L.

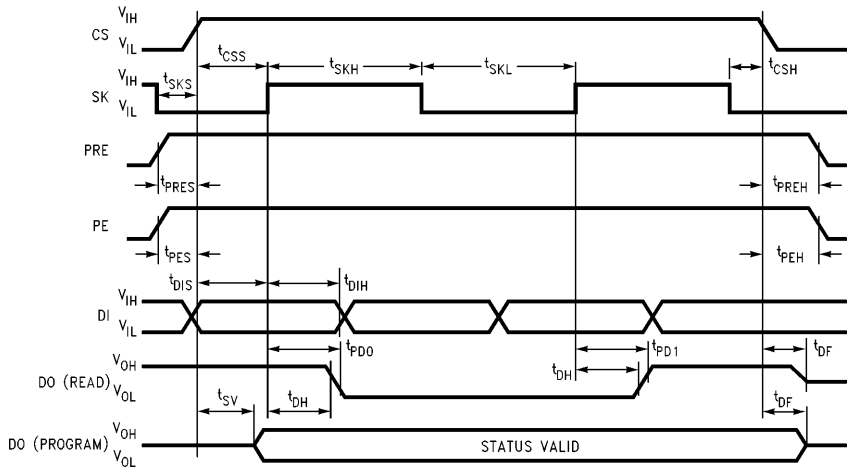
Instruction Set for the NM93CS56L and NM93CS66L

Instruction	SB	Op Code	Address	Data	PRE	PE	Comments
READ	1	10	A7–A0		0	X	Reads data stored in memory, starting at specified address.
WEN	1	00	11XXXXXX		0	1	Enable all programming modes.
WRITE	1	01	A7–A0	D15–D0	0	1	Writes address if unprotected.
WRALL	1	00	01XXXXXX	D15–D0	0	1	Writes all registers. Valid only when Protect Register is cleared.
WDS	1	00	00XXXXXX		0	X	Disables all programming modes.
PRREAD	1	10	XXXXXXXX		1	X	Reads address stored in Protect Register.
PREN	1	00	11XXXXXX		1	1	Must immediately precede PRCLEAR, PRWRITE, and PRDS instructions.
PRCLEAR	1	11	11111111		1	1	Clears the ''protect register'' so that no registers are protected from WRITE.
PRWRITE	1	01	A7–A0		1	1	Programs address into Protect Register. Thereafter, memory addresses ≥ the address in Protect Register are protected from WRITE.
PRDS	1	00	00000000		1	1	**ONE TIME ONLY** instruction after which the address in the Protect Register cannot be altered.

Note: Address bit A7 becomes ''Don't Care'' for the NM93CS56L.

Timing Diagrams

Synchronous Data Timing



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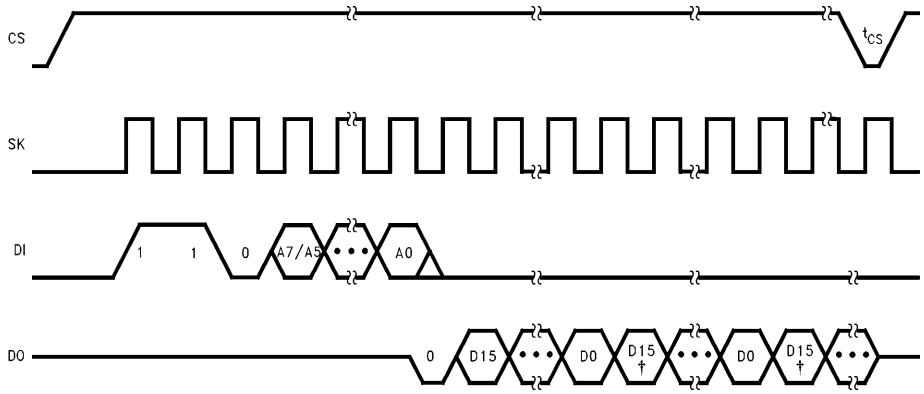
READ:
PRE = 0, PE = X

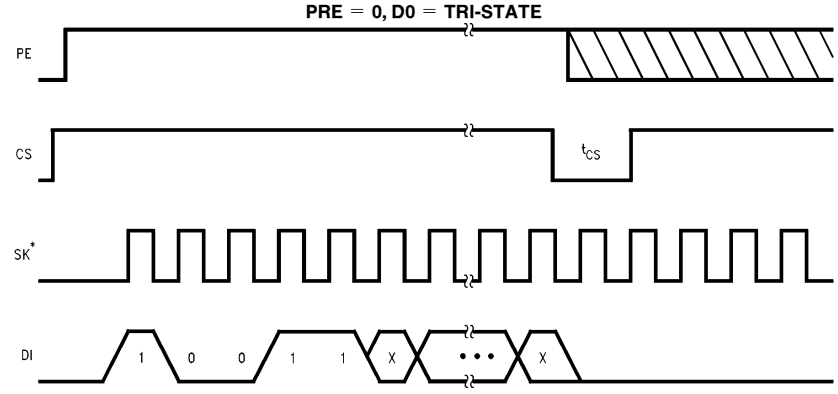


TL/D/10044–5

†The memory automatically cycles to the next register.

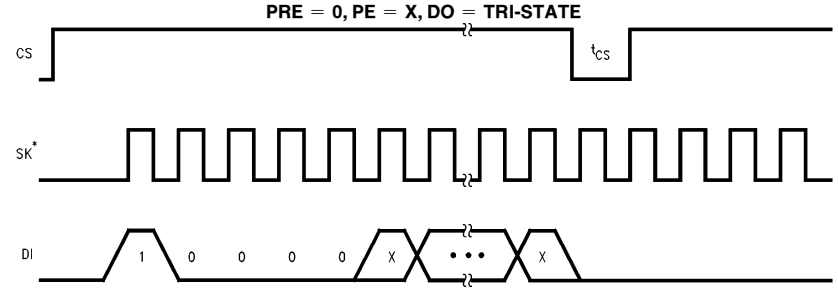
Timing Diagrams (Continued)

WEN:
PRE = 0, D0 = TRI-STATE



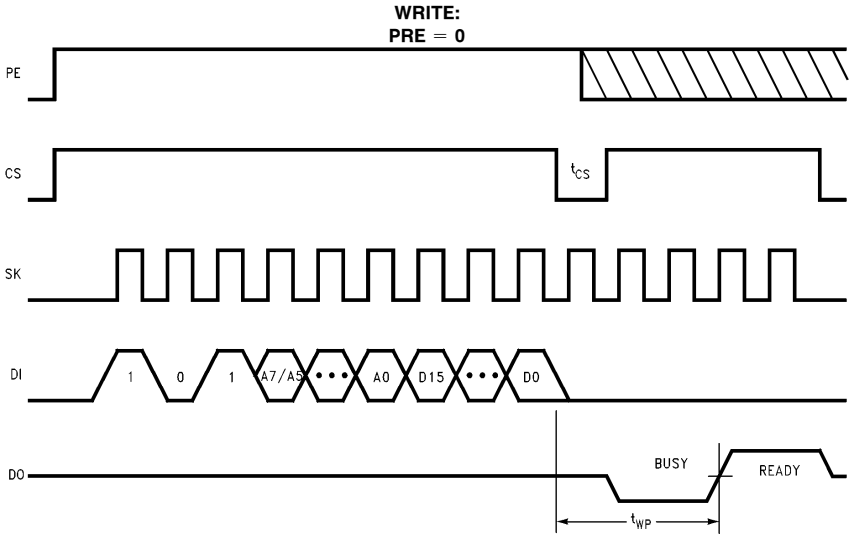
TL/D/10044–6

WDS:
PRE = 0, PE = X, DO = TRI-STATE



TL/D/10044–7

WRITE:
PRE = 0



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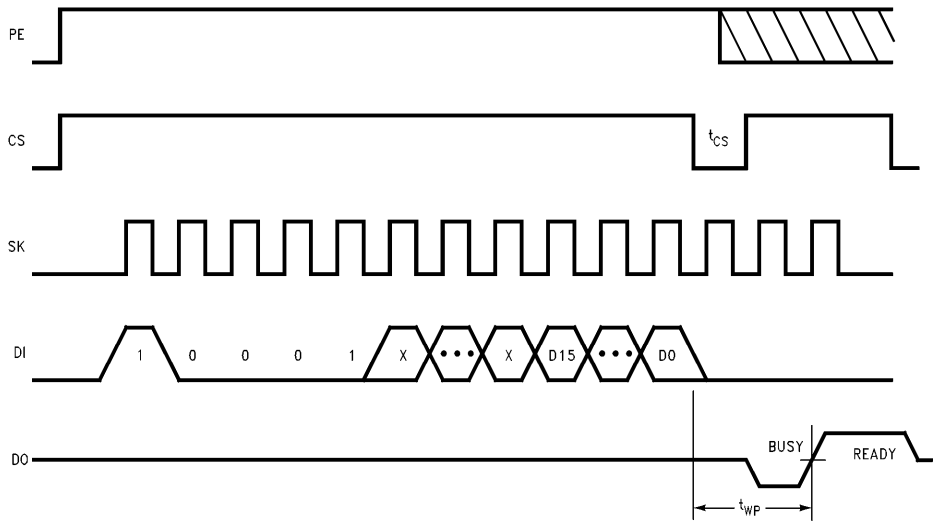
Timing Diagrams (Continued)

WRALL:
PRE = 0
(PROTECT REGISTER MUST BE CLEARED)



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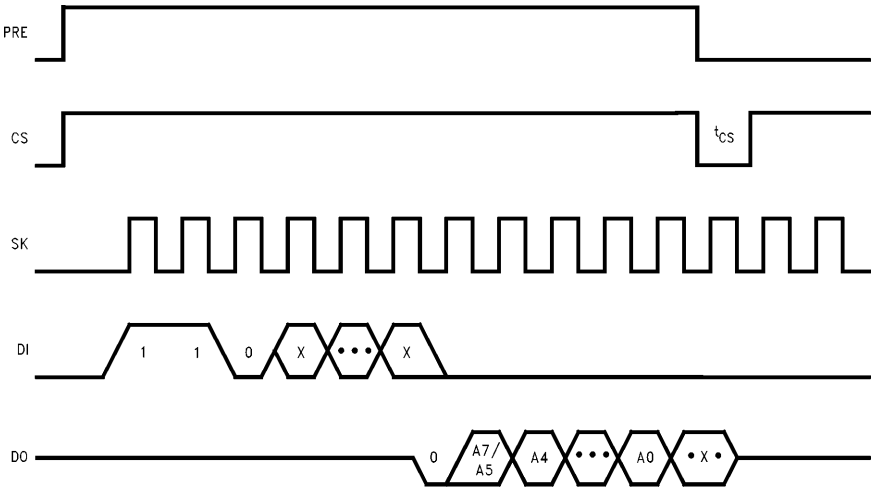
PRREAD:
PE = X



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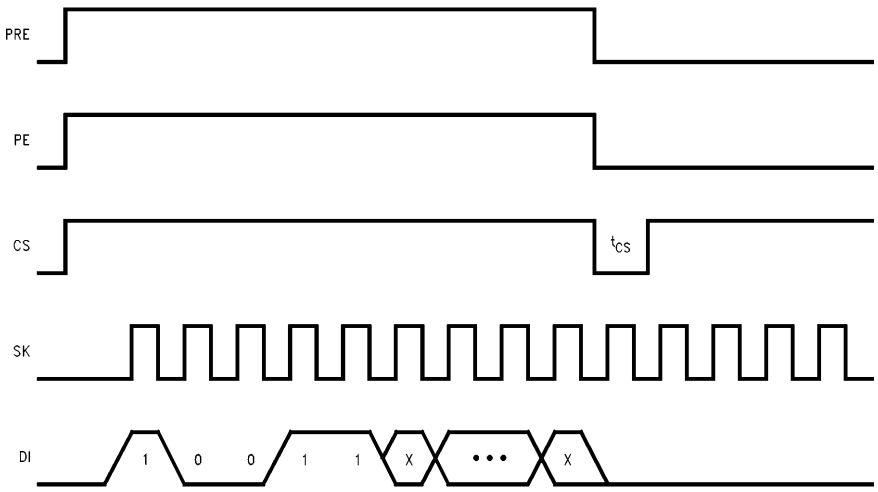
Timing Diagrams (Continued)

PREN:
D0 = TRI-STATE
(A WEN CYCLE MUST PRECEDE A PREN CYCLE)



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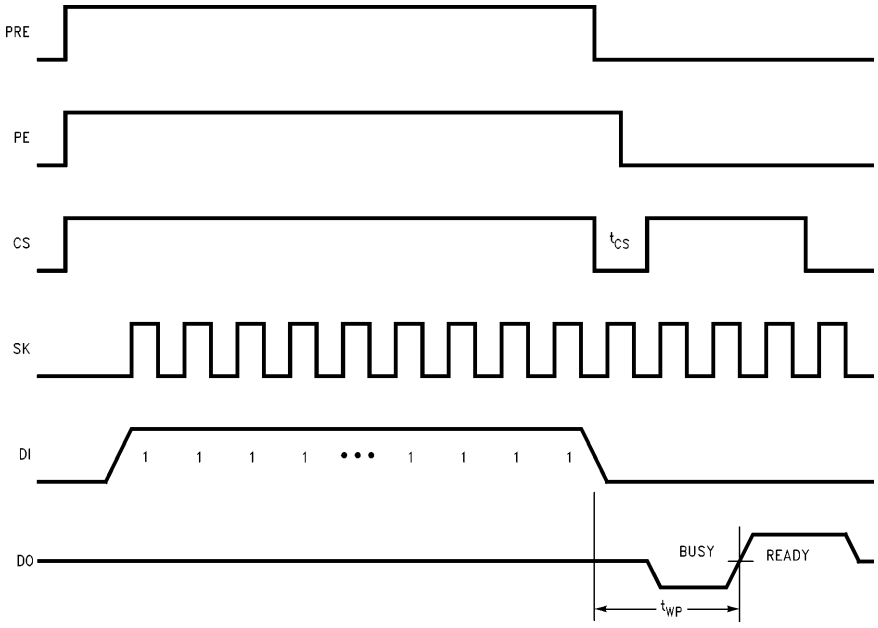
PRCLEAR:
(A PREN CYCLE MUST IMMEDIATELY PRECEDE A PRCLEAR CYCLE)



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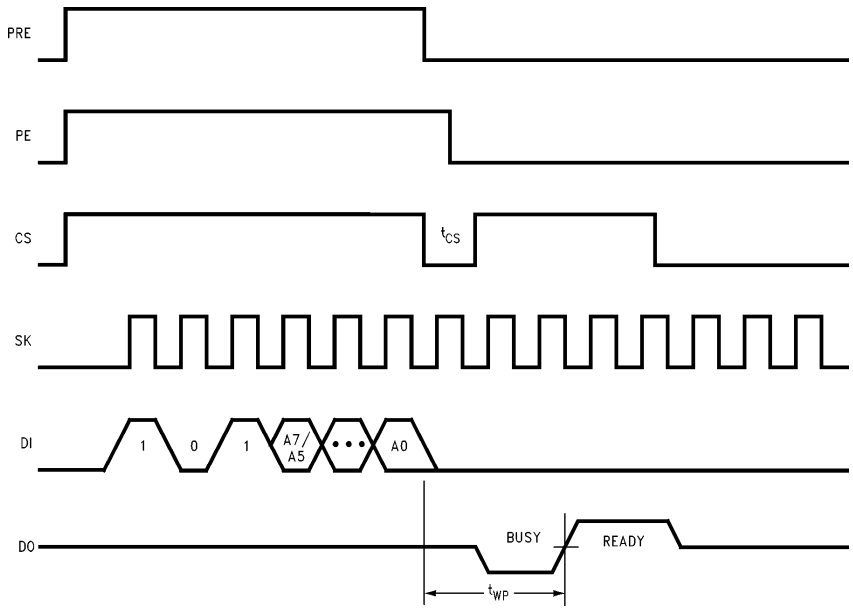
Timing Diagrams (Continued)

PRWRITE:
(A PREN CYCLE MUST IMMEDIATELY PRECEDE A PRWRITE CYCLE.



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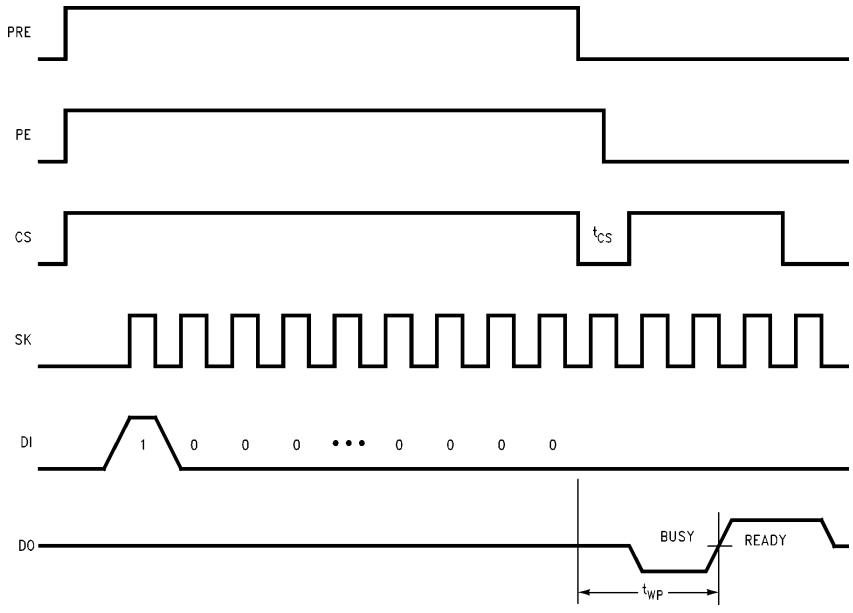
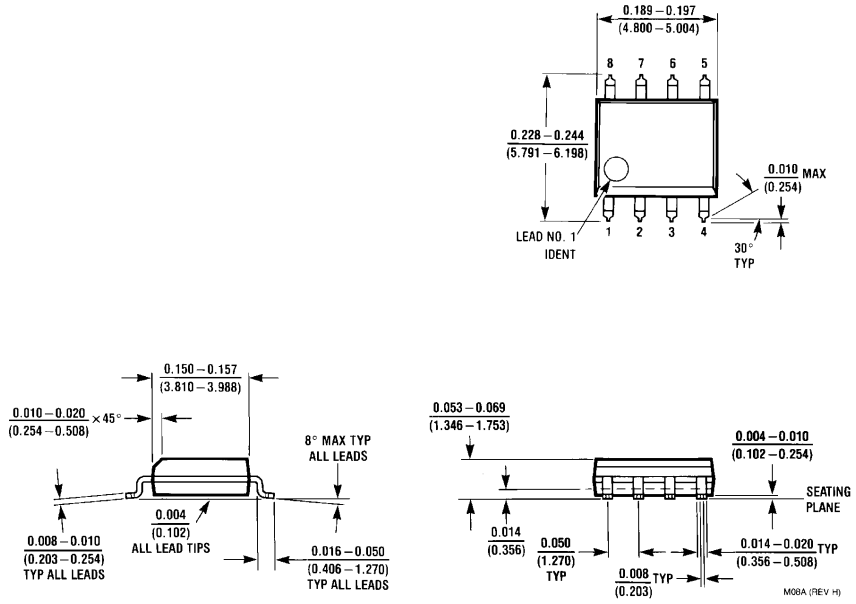
PRDS:
(ONE TIME ONLY INSTRUCTION. A PREN CYCLE MUST IMMEDIATELY PRECEDE A PRDS CYCLE.)

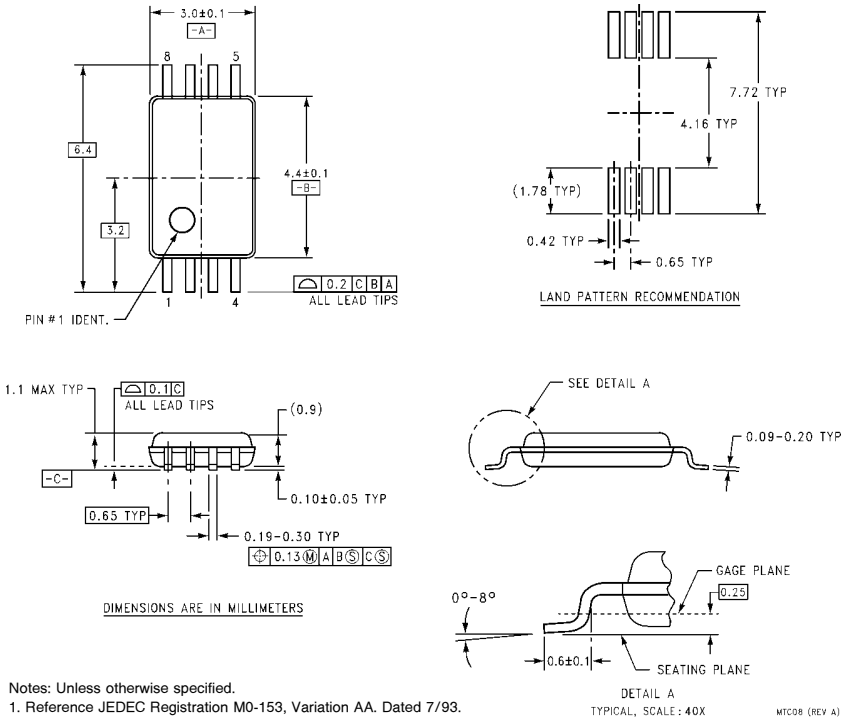


TL/D/10044–14

Physical Dimensions inches (millimeters) unless otherwise noted



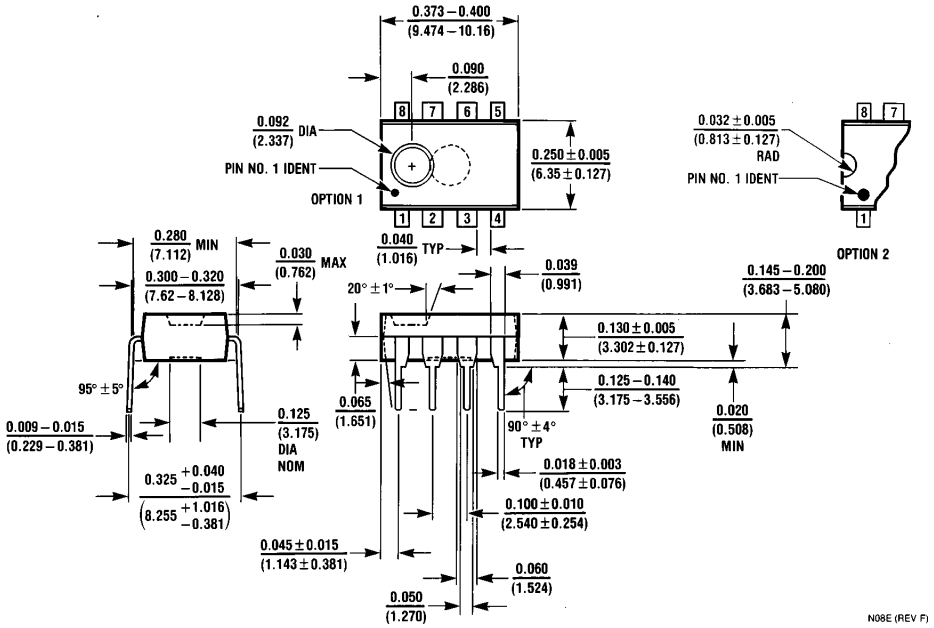
Molded Small Out-Line Package (M8)
NS Package Number M08A



Notes: Unless otherwise specified.
1. Reference JEDEC Registration M0-153, Variation AA. Dated 7/93.

8-Pin Molded TSSOP, JEDEC (MT8)
NS Package Number MTC08

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Molded Dual-In-Line Package (N)
NS Package Number N08E

LIFE SUPPORT POLICY

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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